



(12) **United States Design Patent**  
**McBride et al.**

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(54) **CIRCUIT BOARD**

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(\* ) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: **15 Years**

(21) Appl. No.: **29/891,271**

(22) Filed: **May 3, 2023**

**Related U.S. Application Data**

(60) Continuation of application No. 29/819,031, filed on Dec. 13, 2021, now Pat. No. Des. 989,014, which is a division of application No. 29/767,479, filed on Jan. 22, 2021, now Pat. No. Des. 938,374, said application No. 29/704,995 is a continuation of application No. 16/564,758, filed on Sep. 9, 2019, now Pat. No. 11,251,507, said application No. 29/705,008 is a continuation of application No. 16/564,758, filed on Sep. 9, 2019, now Pat. No. 11,251,507, said application No. 29/767,479 is a continuation-in-part of application No. 29/704,995, filed on Sep. 9, 2019, now Pat. No. Des. 937,792, and a continuation-in-part (Continued)

(51) **LOC (15) Cl.** ..... **13-03**  
(52) **U.S. Cl.**

USPC ..... **D13/182**  
CPC ..... **H01M 10/0525** (2013.01); **H01M 50/103** (2021.01); **H01M 50/204** (2021.01); **H01M 50/256** (2021.01); **H01M 50/296** (2021.01); **H01R 11/287** (2013.01); **H01R 11/288** (2013.01); **H01M 50/227** (2021.01); **H01M 50/278** (2021.01); **H01M 50/516** (2021.01); **H01M 50/517** (2021.01)

(58) **Field of Classification Search**

USPC ..... D13/182; 361/748, 752, 760, 761, 807, 361/808, 736, 719, 720; 174/250, 253, 174/255, 68.1; 363/144, 147  
CPC ..... H05K 3/30; H05K 3/301; H05K 3/284; H05K 3/303; H05K 1/18; H05K 1/181; H05K 1/182; H05K 1/183; H05K 1/185; H05K 1/00; H05K 7/1417; H05K 7/02; H05K 7/12; H05K 7/06; H01L 2924/14  
See application file for complete search history.

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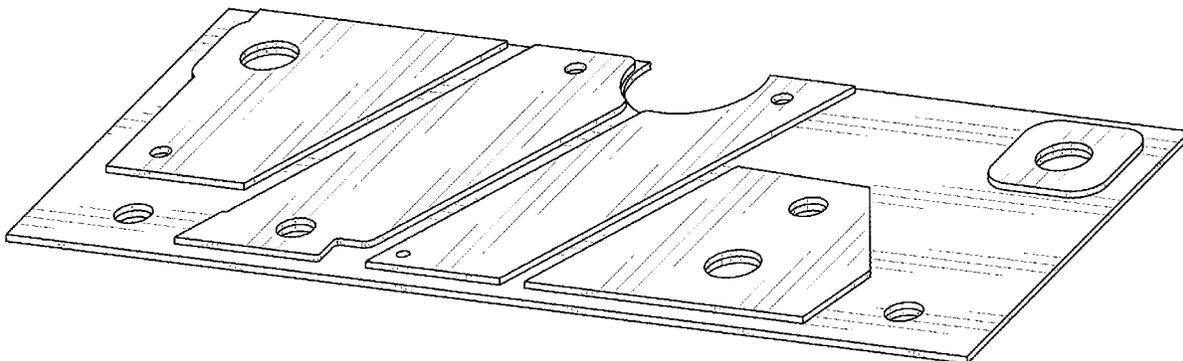
(57) **CLAIM**

The ornamental design for a circuit board, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a circuit board showing our new design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a right side elevational view thereof;  
FIG. 4 is a left side elevational view thereof;  
FIG. 5 is a top plan view thereof; and,  
FIG. 6 is a bottom plan view thereof.  
All surfaces not shown form no part of the claimed design.

**1 Claim, 6 Drawing Sheets**



**Related U.S. Application Data**

of application No. 29/705,008, filed on Sep. 9, 2019,  
now Pat. No. Des. 937,793.

(56)

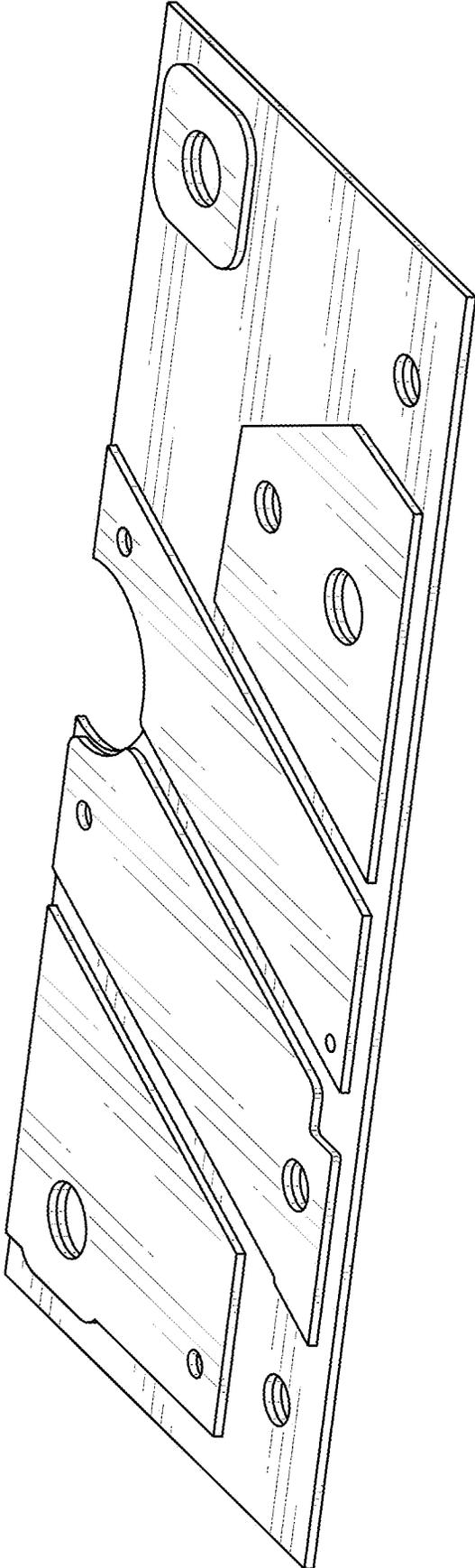
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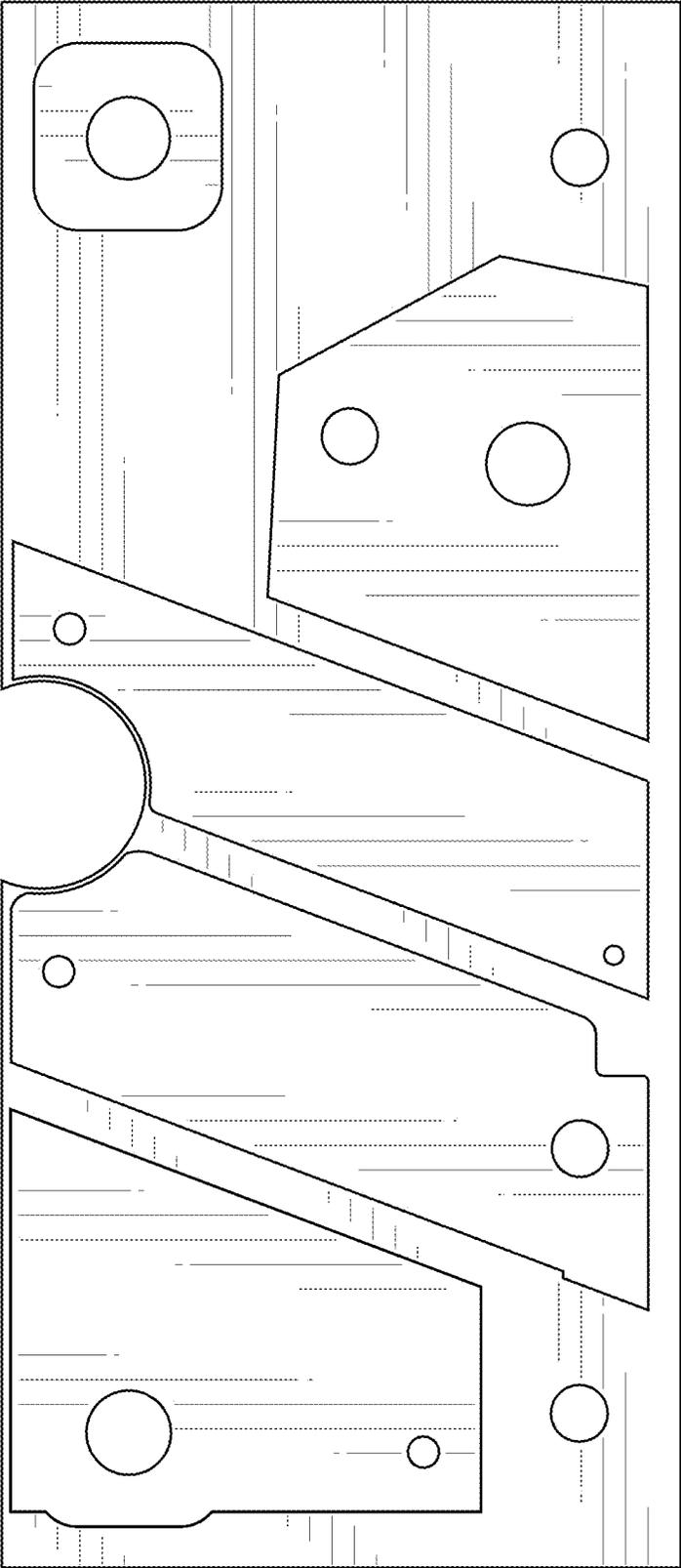
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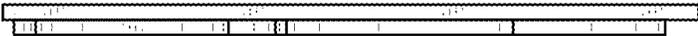
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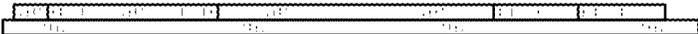
**FIG. 1**



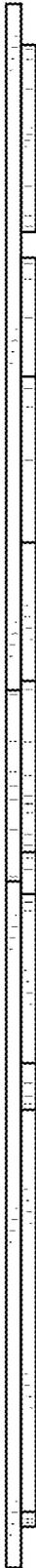
**FIG. 2**



**FIG. 3**



**FIG. 4**



**FIG. 5**



**FIG. 6**